

DATASHEET & RELIABILITY DATA

SD3 SERIES

(주)오디피

Open Digital Power Corp.

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MAX. Power 3.0W Isolated DC-DC Converter

SDS3 Series Small Compact Size DC-DC Converter



Features

- Small Compact Size
- High Efficiency
- Isolated Input - Output
- Wide operating temperature range (-40°C to 85°C)
- Long Life Design (Employ only Ceramic Capacitor)
- Built-in over current protection circuit
- Wide 2 : 1 input range
- Adjustable output voltage (single output)
- Safety standard : CE approved
- RoHS compatible design

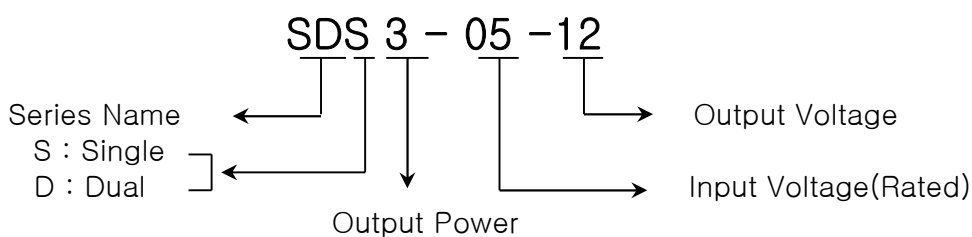
Applications

- Data and telecommunication
- FA control
- Datacommunication electronic equipments

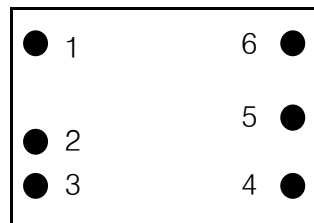
Environment

- Operating Temperature : -40°C ~ 85°C
- Operating Humidity : 5% ~ 95% RH (Non condensing)
- Storage Temperature : -40°C ~ 105°C
- Cooling : Free-Air Convection
- MTBF : 8.0 x 10⁵ hrs

Model Name Structure



Pin assignments & Function



<Top View>

- Single Output Name & Function

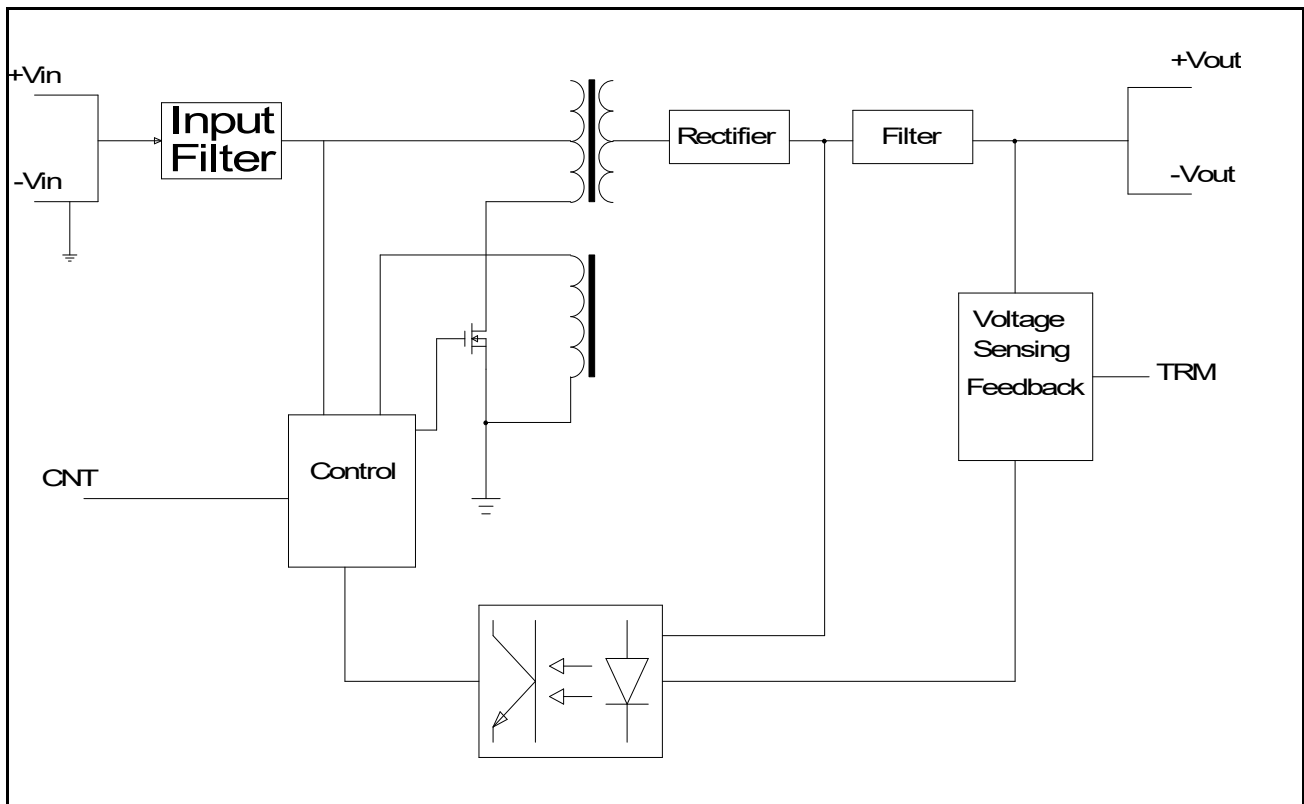
PIN No.	NAME	FUNCTION
1	+Vin	Positive terminal for Vin
2	-Vin	Negative terminal for Vin
3	CNT	Remote on/off Control
4	TRM	Vout variation($\pm 10\%$) by external parts
5	-Vout	Negative terminal for Vout
6	+Vout	Positive terminal for Vout

- Dual Output Name & Function

PIN No.	NAME	FUNCTION
1	+Vin	Positive terminal for Vin
2	-Vin	Negative terminal for Vin
3	CNT	Remote on/off Control
4	-Vout	Negative terminal for Vout
5	Com	The common ground of Vout
6	+Vout	Positive terminal for Vout

- Datasheet

1. Internal Circuit Architecture



2. Maximum Ratings

Characteristics		Symbol	Min.	Typ.	Max.	Unit
Input Voltage Continuous	SDS3 - 05 - XX	Vin	4.5	-	9.0	VDC
	SDS3 - 12 - XX		9.0	-	18.0	
	SDS3 - 24 - XX		18.0	-	36.0	
	SDS3 - 48 - XX		36.0	-	76.0	
Operating Ambient Temperature		Ta	-40	-	85	°C
Storage Temperature		Tstg	-40	-	105	°C
Withstand Voltage			-	-	500	Vac

3. Electrical Characteristics

– Input Section

Ta : 25°C, Vin : Typical Input Voltage

Characteristics		Symbol	Min.	Typ.	Max.	Unit
Operating Voltage Range	SDS3 - 05 - XX	Vin	4.5	5.0	9.0	VDC
	SDS3 - 12 - XX		9.0	12.0	18.0	
	SDS3 - 24 - XX		18.0	24.0	36.0	
	SDS3 - 48 - XX		36.0	48.0	76.0	
Maximum Input Current (Vin : rated, Io : 100%)	SDS3 - 05 - XX	Iin		0.769		A
	SDS3 - 12 - XX			0.305		
	SDS3 - 24 - XX			0.152		
	SDS3 - 48 - XX			0.078		
Maximum No Load Input Current (Vin : rated)	SDS3 - 05 - XX			46		mA
	SDS3 - 12 - XX			27		
	SDS3 - 24 - XX			10		
	SDS3 - 48 - XX			7		

– Output Section

Ta : 25°C, Vin : Minimum, Typical, Maximum Input Voltage

Characteristics		Symbol	Min.	Typ.	Max.	Unit
Output Voltage Accuracy		Vo	-	-	±2	%
Regulation	Line Regulation (From min. Vin to max. Vin, constant load)		-	-	±0.5	%
	Load Regulation (From no load to maximum load)		-	-	±1	%
Output Ripple and Noise (Vin : Rated, Io : Max., BW : 20MHz, use the external capacitor(1uF) between +Vo and -Vo)		mVp-p	-	-	1% of Vout	mV (peak to peak)

Characteristics		Symbol	Min.	Typ.	Max.	Unit
Output Current	SDS3 - XX - 3R3	I _o	-	-	0.6	A
	SDS3 - XX - 05		-	-	0.6	
	SDS3 - XX - 12		-	-	0.25	
	SDS3 - XX - 15		-	-	0.2	
Output Current Limit (OCP : Over Current Protection, recovers automatically)			105	-	-	%
Dynamic Load Response (V _{in} : rated, I _o : from 50% to 100%, from 100% to 50%, BW : 20MHz, Freq. : 100Hz, Duty : 0.5, Tr/Tf : 100us use the external capacitor(1uF) between +Vo and -Vo)			-	-	3% of V _{out}	mV (peak to peak)
Start - Up Time		T _{start}	-	-	10	ms
Turn - on Overshoot			-	-	5	%
Efficiency (V _{in} : Rated, I _o : Max.)	SDS3 - 05 - 3R3		-	73	-	%
	SDS3 - 05 - 05		-	78	-	
	SDS3 - 05 - 12		-	81	-	
	SDS3 - 05 - 15		-	81	-	
	SDS3 - 12 - 3R3		-	77	-	%
	SDS3 - 12 - 05		-	82	-	
	SDS3 - 12 - 12		-	86	-	
	SDS3 - 12 - 15		-	87	-	
	SDS3 - 24 - 3R3		-	77	-	%
	SDS3 - 24 - 05		-	82	-	
	SDS3 - 24 - 12		-	86	-	
	SDS3 - 24 - 15		-	87	-	
	SDS3 - 48 - 3R3		-	73	-	%
	SDS3 - 48 - 05		-	80	-	
	SDS3 - 48 - 12		-	83	-	
	SDS3 - 48 - 15		-	83	-	

4. Isolation Characteristics

Characteristics		Symbol	Min.	Typ.	Max.	Unit
Withstand Voltage (AC500V, 1minute)	Input – Output		–	–	500	Vac
	Input – Case		–	–	500	Vac
	Output – Case		–	–	500	Vac
Isolation Resistance (DC500V at 25°C and 70%RH)	Output – Case	Riso	100	–	–	MΩ

5. General Characteristics

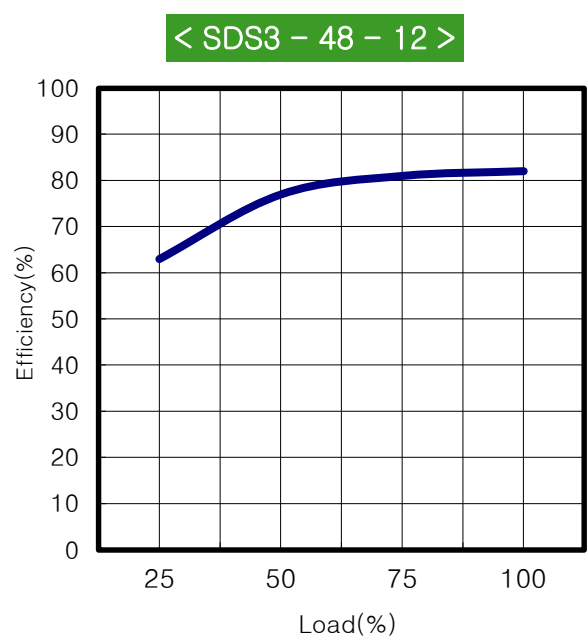
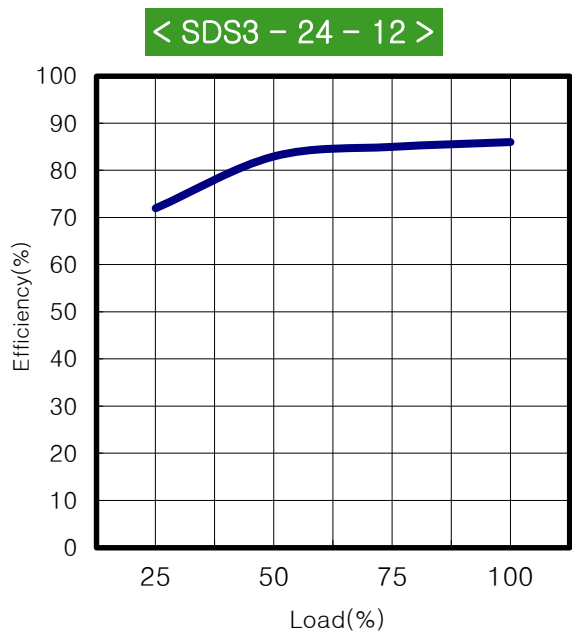
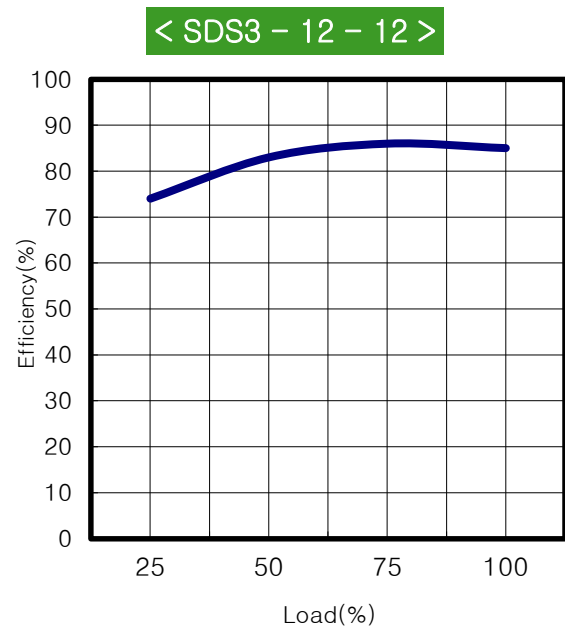
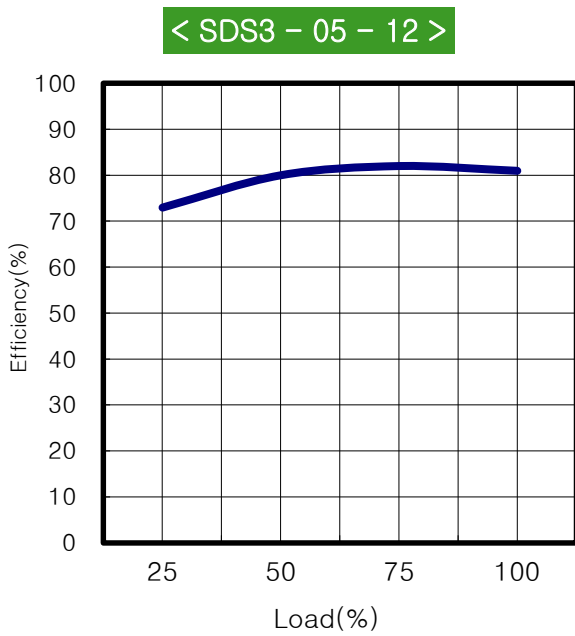
Characteristics	Symbol	Min.	Typ.	Max.	Unit
Remote on / off control (CNT Pin, Negative Logic Module on : Logic Low or Short to -Vin Module off : Logic High or open)	CNT				
External Trim Adj. Range (TRM Pin, Vout variation by external parts)	TRM	-10	–	+10	%
Switching Frequency					kHz
MTBF (MIL-HDBK-217F)		8.0 x 10 ⁵			hrs
Dimension (W x H x L)		23.4 x 8.5 x 16.0			mm
Weight		–	4.0	–	grams

6. Environment

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Operating Temperature Range	Ta	-40	–	85	°C
Operating Humidity (non Condensing)		5	–	95	%RH
Storage Temperature	Tstg	-40	–	105	°C

7. Characteristics Curves

Efficiency Curves



- Reliability Data

1. MTBF

Calculating Reliable Values of MTBF

Calculated based on part count reliability projection of MIL-HDBK-217F individual failure rates λg is given to each part and MTBF is calculated by the count of each part.

Method is :

$$MTBF = \frac{10^6}{\sum_{i=1}^{i=n} Ni(\lambda g \cdot \pi Q)_i} = \frac{10^6}{\lambda_{equip}} \quad [\text{hours}]$$

For a given equipment environment where :

λ_{equip} = Total equipment failure rate (Failures / 10^6 Hours)

λg = Generic failure rate for the i th generic part (Failures / 10^6 Hours)

πQ = Quality factor for the i th generic part ($\pi Q = 1$)

Ni = Qty of i th generic part

n = Number of different generic part categories in the equipment

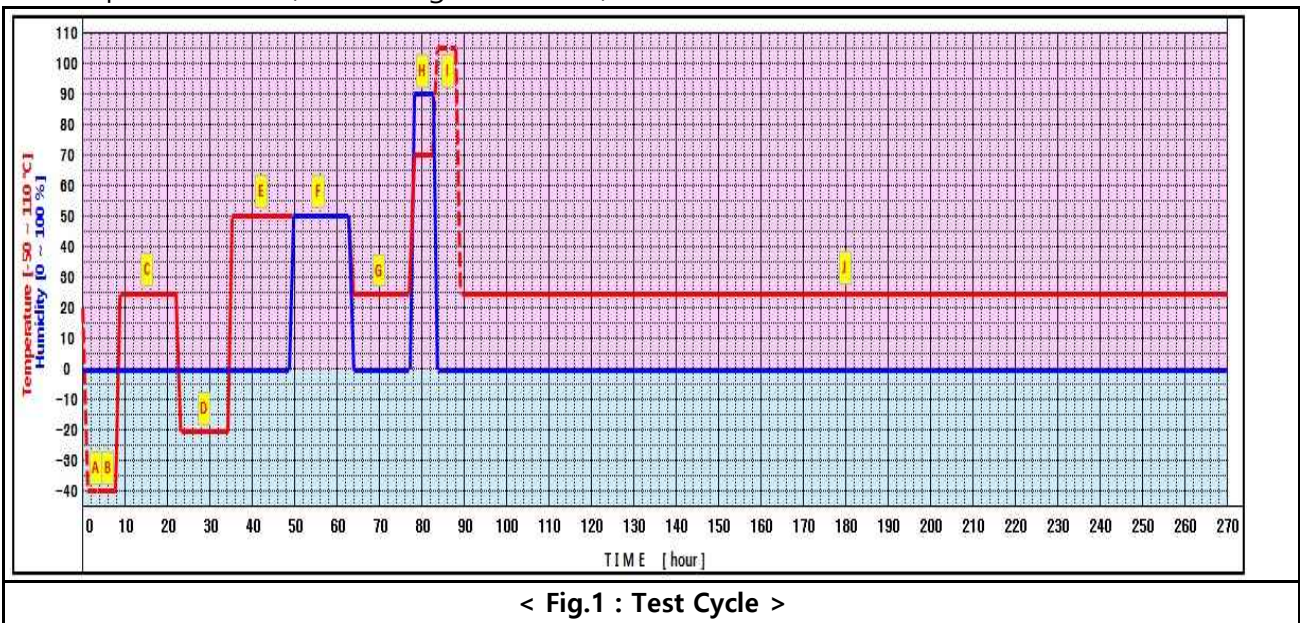
	PART	Number	Failure Rate	Failure Rate
1	Logic IC	0	0.015	-
2	FET	3	0.012	0.0360000
3	Voltage Regulaor	1	0.002	0.0020000
4	Diode (Zener)	1	0.002	0.0020000
5	Diode (FRD)	0	0.069	-
6	Diode (SBD)	3	0.027	0.0810000
7	Bridge Diode	0	0.066	-
8	LED	0	0.00023	-
9	Varistor	0	0.0013	-
10	Photo-coupler	1	0.07	0.0700000
11	Thyristor	0	0.0022	-
12	Elec.- Cap.	0	0.019	-
13	Ceramic Cap.	7	0.026	0.1820000
14	MLCC	3	0.053	0.1590000
15	Choke coil	2	0.00022	0.0004400
16	Switching transformer	1	0.0042	0.0042000
17	Line Filter	0	0.0044	-
18	Resistor	15	0.0024	0.0360000
19	Resistor Variable	0	0.0024	-
20	Thermister	0	0.0019	-
21	Connertor	0	0.052	-
22	Soldering Point	38	0.0078	0.2964000
23	PCB	1	0.37	0.3700000
24	Fuse	1	0.01	0.0100000
Total Equipment Failure Rate (λ_{equip})				1.2490400
MTBF = $10^6 / \lambda_{equip}$ (F/T)				800,614.872
MTBF \approx 800,000[Hours]				

2. Environmental Stress Test(EST)

The purpose of the environment stress test is to ensure reliability by setting in advance the following environment and verified.

- transport process and conservation status
- environmental change conditions that can be applied to the product from the process of the end-user

Test cycle consists of 10 segments(total 270 hours). Test results of all segments must meet the specifications. (refer to Fig.1 & Table1)



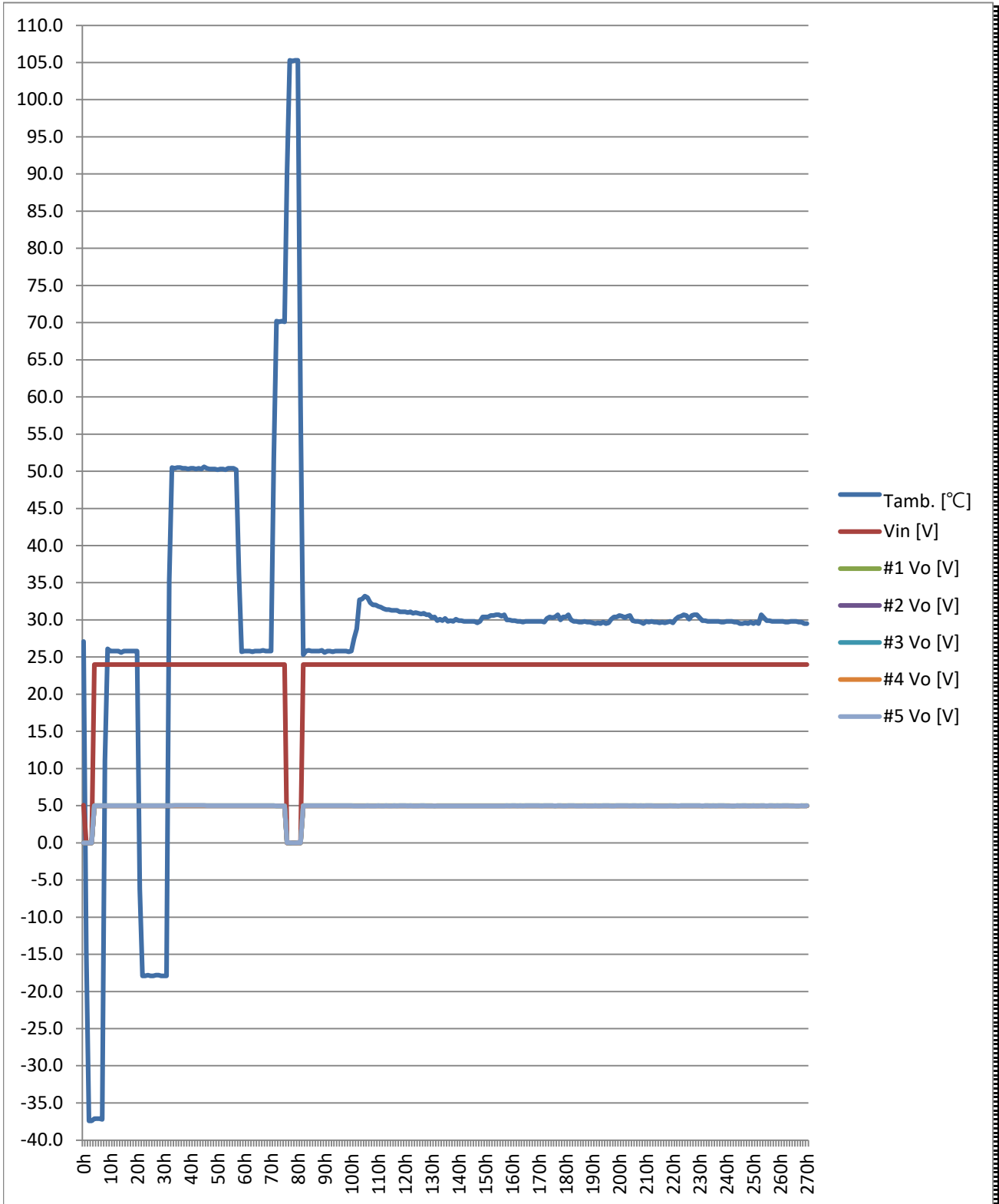
Segment	Time	Temp.	Humidity	Description	Input 'SW'
A	2 hours	-40°C	0%	Low temperature storage	off
B	4 hours	-40°C	0%	Low temperature operation	on
C	12 hours	25°C	0%	Room temperature operation	on
D	10 hours	-20°C	0%	Low temperature operation	on
E	12 hours	50°C	0%	High temperature operation	on
F	12 hours	50°C	50%	High-temperature & humidity operation	on
G	12 hours	25°C	0%	Room temperature operation	on
H	4 hours	70°C	90%	High-temperature & humidity operation	on
I	4 hours	105°C	0%	High temperature storage	off
J	189 hours	25°C	0%	Room temperature operation	on

< Table1 : Segment Description >

2.1. Environmental Stress Test Results

a. Test Sample : SDS3-24-05

b. 270 hours in one cycle test graph



c. Characteristics test results (@ Input Voltage : 24VDC, Output Load : 0.49A(81.7% of Full load))

Segment	Test Time	T _{amb} /Humi.	Output Voltage	Start up	Ripple / Noise [mVp-p]	Sapmle No.
A	3h	-40°C / 0%	5.01V	OK	18 / 36	# 1
			4.99V	OK	18 / 36	# 2
			4.99V	OK	18 / 38	# 3
			4.99V	OK	18 / 36	# 4
			5.01V	OK	18 / 34	# 5
B	7h	-40°C / 0%	5.01V	OK	16 / 34	# 1
			4.99V	OK	16 / 32	# 2
			4.99V	OK	16 / 34	# 3
			4.99V	OK	16 / 36	# 4
			5.01V	OK	16 / 33	# 5
C	10h	25°C / 0%	5.01V	OK	13 / 20	# 1
			4.99V	OK	13 / 20	# 2
			4.99V	OK	11 / 23	# 3
			4.99V	OK	13 / 19	# 4
			5.00V	OK	11 / 21	# 5
D	24h	-20°C / 0%	5.01V	OK	14 / 28	# 1
			5.00V	OK	15 / 28	# 2
			4.99V	OK	15 / 27	# 3
			4.99V	OK	15 / 24	# 4
			5.01V	OK	15 / 27	# 5
E	33h	50°C / 0%	5.00V	OK	13 / 22	# 1
			4.98V	OK	13 / 23	# 2
			4.98V	OK	12 / 26	# 3
			4.98V	OK	11 / 28	# 4
			5.00V	OK	12 / 24	# 5
F	48h	50°C / 50%	5.01V	OK	13 / 26	# 1
			4.98V	OK	13 / 28	# 2
			4.99V	OK	12 / 28	# 3
			4.98V	OK	11 / 33	# 4
			5.00V	OK	12 / 28	# 5
G	57h	25°C / 0%	5.00V	OK	13 / 24	# 1
			4.98V	OK	13 / 24	# 2
			4.99V	OK	13 / 26	# 3
			4.98V	OK	13 / 27	# 4
			5.00V	OK	13 / 28	# 5
H	72h	70°C / 90%	4.99V	OK	14 / 28	# 1
			4.97V	OK	15 / 32	# 2
			4.98V	OK	15 / 33	# 3
			4.98V	OK	14 / 29	# 4
			4.99V	OK	14 / 33	# 5
I	81h	25°C / 0%	5.01V	OK	13 / 26	# 1
			4.99V	OK	13 / 24	# 2
			4.99V	OK	13 / 28	# 3
			4.98V	OK	13 / 28	# 4
			5.00V	OK	13 / 28	# 5
J	270h	25°C / 0%	5.00V	OK	13 / 24	# 1
			4.98V	OK	13 / 25	# 2
			4.98V	OK	13 / 28	# 3
			4.98V	OK	13 / 28	# 4
			5.00V	OK	13 / 26	# 5
Test Result			Pass	Pass	Pass	

3. Main Components Δt Test

The purpose of the test is to ensure the reliability and margin by measuring the heating value of the main components.

3.1. SDS3-24-12 (@ 100% Load)

Test Point	Test Condition	Vin : 18VDC		Vin : 24VDC	
		T _{amb.}	24.1°C	T _{amb.}	24.0°C
		T _c	Δt	T _c	Δt
FET		51.3°C	27.2°C	50.4°C	26.4°C
Trans Coil		49.4°C	25.3°C	48.6°C	24.6°C
Trans Core		49.8°C	25.7°C	50.0°C	26.0°C
Output Diode		50.6°C	26.5°C	50.8°C	26.8°C

4. Derating of Semiconductor

Compare T_{jmax}(maximum junction temperature) and T_j and is expressed as a percentage. T_j is the value calculated by the temperature of the case and the power dissipation and the thermal impedance.

- Measuring Components : FET, Rectifier diode
- Calculating method of derating ratio

$$\text{Derating Ratio} = \frac{T_j}{T_{j(max)}} \times 100 \text{ [%]}$$

$$T_j = T_c + (R_{\theta(j-c)} \times P_d)$$

T_c : Case Temperature

R_{θ(j-c)} : Thermal impedance between junction and case

P_d : Power dissipation

4.1. SDS3-24-12

Components	Condition	Vin : 18VDC	Load : 100%	T _{amb.} : 50°C
Q1 (FET)		T _{j(max)} : 150 °C	P _d : 0.24 W	Derating Ratio = 56.3%
		R _{θ(j-c)} : 30 °C/W	T _j = 84.4 °C	
		T _c : 77.2°C		
D4 (Rectifier Diode)		T _{j(max)} : 150 °C	P _d : 0.16 W	Derating Ratio = 58.5%
		R _{θ(j-c)} : 70 °C/W	T _j = 87.7 °C	
		T _c : 76.5°C		

5. Abnormal Test

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Report Reference No.: ITYA0703708



Clause	Requirement – Test					Result – Remark	Verdict
5.3	TABLE: fault condition tests						P
	ambient temperature (°C)					22 °C	—
	model/type of power supply					SDS1R5, SDS3	—
	manufacturer of power supply					Open Digital Power	—
	rated markings of power supply					5 – 48Vd.c.	—
component No.	fault	test voltage (V)	test time	fuse No.	fuse current (A)	result	
Reverse input	-	5/12/24/48	10 min	F1	3 - 1A	Immediately fuse(F1) opened. No hazard.	
C1	s/c	5/12/24/48	1 sec	F1	3 - 1A	Immediately fuse(F1) opened. No hazard.	
PC1 #3-4	s/c	5/12/24/48	10 min	F1	3 - 1A	Immediately output shutdown. No hazard.	
PC1 #-12	s/c	5/12/24/48	1 sec	F1	3 - 1A	Immediately fuse(F1) opened. No hazard.	
Output	s/c	5/12/24/48	30 min	F1	3 - 1A	Immediately output shutdown. No hazard.	
Q1 # 1-2	s/c	5/12/24/48	1 sec	F1	3 - 1A	Immediately fuse(F1) opened. No hazard.	
T1 # 1-5	s/c	5/12/24/48	30 min	F1	3 - 1A	Normal operation. No hazard.	
T1 # 3-5	s/c	5/12/24/48	30 min	F1	3 - 1A	Normal operation. No hazard.	
T1 # 1-7	s/c	5/12/24/48	30 min	F1	3 - 1A	Normal operation. No hazard.	
supplementary information							
s/c: short circuit, #: pin No.,							

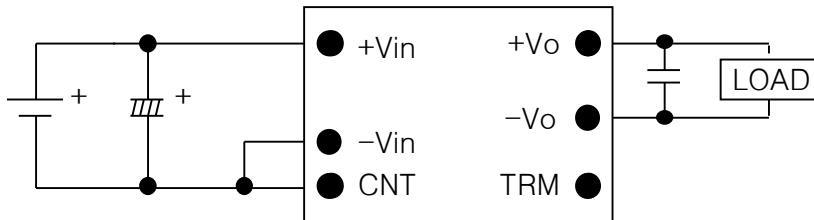
Note Before placing the products in the different countries the manufacturer has to guarantee that:

1. Operating instructions and warnings are written in an accepted language of the certain country.
2. The equipment is in compliance with the national standards of the certain country.

Test Report EN/IEC 60950-1b Rev. 00 / 2003-04

- Application Sheet

1. Basic Connection



2. Input Section

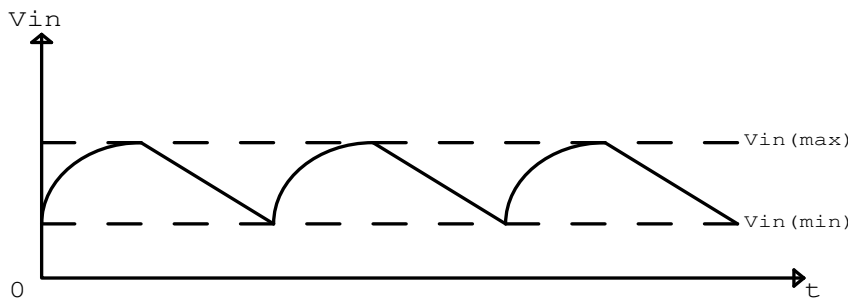
- Input fuse

In order to comply with safety requirements, SDS series has a fuse(Slow Blow Type) built in.

	SDS1R5 Series	SDS3 Series	SDS6 Series	SDS10 Series
5V	2A	3A	5A	6A
12V	1A	2.5A	2.5A	4A
24V	1A	1A	2A	2.5A
48V	1A	1A	1.5A	2A

- Unstable Input

Input voltage is comprised of both the DC voltage(average rectified voltage)and the peak to peak ripple voltage. Peak to peak ripple voltage should be minimized so that the input voltage is within the standard input voltage range as follows.



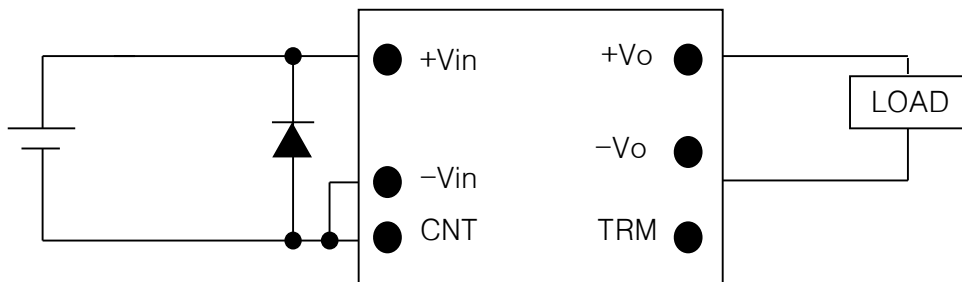
< Unstable Input >

- Battery Input

When using a battery as the input power supply, make sure that the maximum and minimum input voltage do not away out of the standard input voltage range.

- Input Reverse-polarity voltage protection

Accidently reversing the input connections could damage the module. Thus. If the connections may be accidentally reversed. Use a protective diode and an input fuse as shown below.



- Remote On/Off Control(CNT) (Except SDS1R5 Series)

Without switching the input on/off, the output can be enabled and disabled using this function. This function is useful for sequence control when building multiple output power supplies. This control circuit is on the input side using the CNT pin. Ground of CNT pin is the input -V terminal. When not using this function, short CNT to input -V terminal.

CNT level for -Vin		OUTPUT
Low level	Short to -Vin	ON
High level	Open	OFF

< Negative Logic on/off Control >

3. Output Section

- Output Ripple and Noise Measurement Method

The measurement for output ripple and noise are based on normal probe with 20MHz bandwidth scope. Upon measurement of the ripple voltage, make sure that the scope probe leads are not too long. If a precise measurement can be made, the noise occurs from circumference must be reduced.

- Line Regulation

The line regulation means to the change in output voltage when the input voltage is varied within the input voltage range, at constant load and constant ambient temperature. The measurement point for the input and output voltage are $\pm V_{in}$ pins, $\pm V_{out}$ pins respectively.

- Load Regulation

The load regulation means to the change in output voltage when the load is changed from minimum load to maximum load, at constant input voltage and constant ambient temperature. The measurement point for the input and output voltage are $\pm V_{in}$ pins, $\pm V_{out}$ pins respectively.

- Output Voltage adjustment (TRM)

The output voltage can be varied within $\pm 10\%$ of the standard output voltage when use the external parts-resistors and variable resistor.

External Resistors :

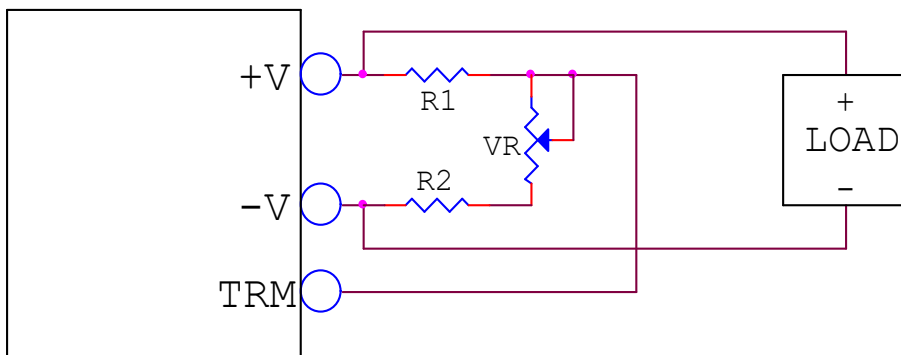
Resistance tolerance $\pm 5\%$

Variable Resistor(VR) :

Total resistance toloatace $\pm 20\%$

Remaining Resistance : Value less than 1%

V_o	R1	R2	VR
3.3V	1.5k Ω	680 Ω	1k Ω
5V	1k Ω	680 Ω	1k Ω
12V	3.9k Ω	680 Ω	1k Ω
15V	5.6k Ω	750 Ω	1k Ω
$\pm 12(24V)$	12k Ω	1k Ω	1k Ω
$\pm 15(30V)$	15k Ω	1k Ω	1k Ω



< Trim Method >

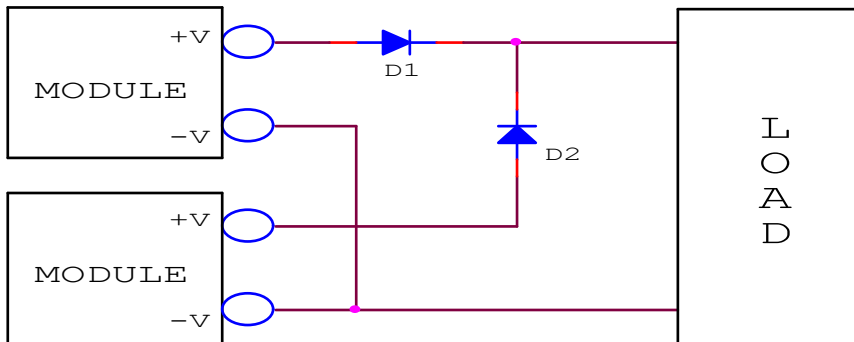
- Over Current Protection

The SDS series is built into an OCP(Over Current Protection) circuit. When the OCP triggers, the output voltage will be fall. If overload condition is removed, the output will automatically recover.

4. Operation Method

Parallel Operation

The module can be operated parallel connection. Refer to diagram as shown below.



Please, you must consider both revers voltage and forward current of diode, when you choose a diode.

Maximum reverse voltage(V_{rm}) : $V_{rm} > 1.5 \times V_o$

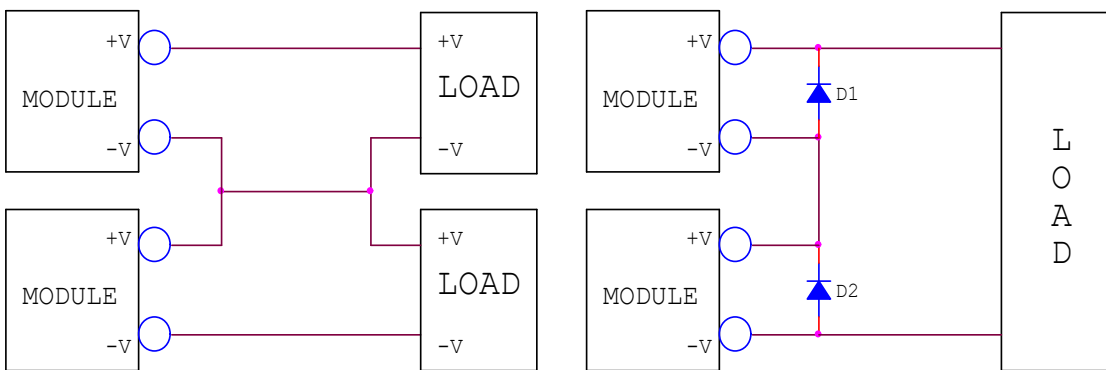
Forward current(I_f) : $I_f > 3 \times I_o$

Also, design a heatsink according to power loss at diode. If you want to reduce power loss, use a schottky barrer diode.

Power loss = V_f(forward voltage) X I_o(output current)

Series Operation

Series operation is available by connecting the outputs of two or more module as shown below.



< A. General Series Operation >

< B. Complemental Series Operation >

Please, you must consider both revers voltage and forward current of diode, when you choose a diode.

Maximum reverse voltage(V_{rm}) : $V_{rm} > 1.5 \times V_o$

Forward current(I_f) : $I_f > 3 \times I_o$

Also, design a heatsink according to power loss at diode. If you want to reduce power loss, use a schottky barrer diode.

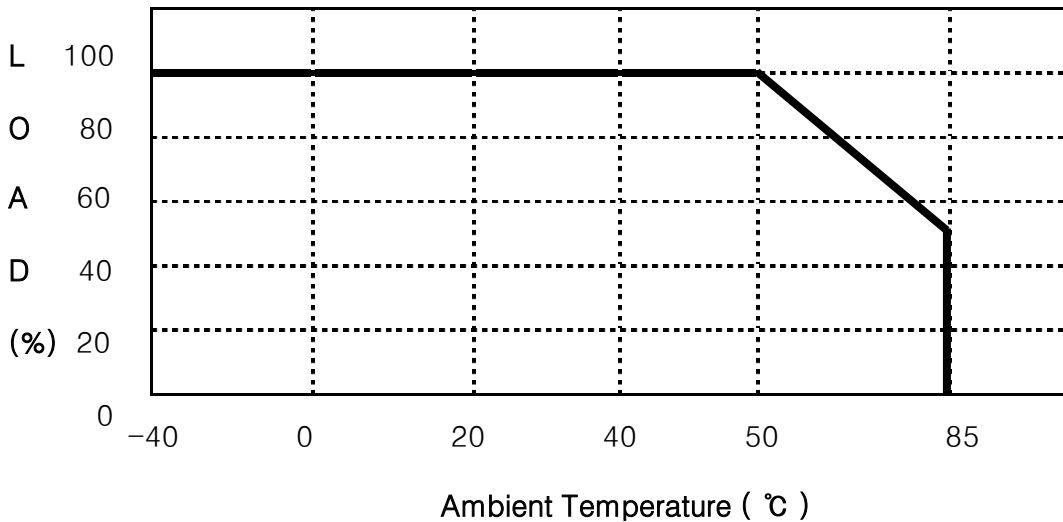
Power loss = V_f(forward voltage) X I_o(output current)

5. Environment

- Temperature

Operation Temperature

The range of ambient temperature in °C over which a module can be operated safely at either rated or derated output power. Refer to derating curve as shown below.



※ Operating Temperature Range : From -40°C to 85°C

< Derating Curve >

Storage Temperature

The range of ambient temperature in °C over which a module may be stored long term without damage. The storage temperature range is from -40°C to 105°C.

- Humidity

Operation Humidity

The range of ambient humidity in % over which a module can be operated safely at either rated or derated output power. Refer to derating curve as shown below. The operating humidity range is from 5% to 95%RH.

Storage Humidity

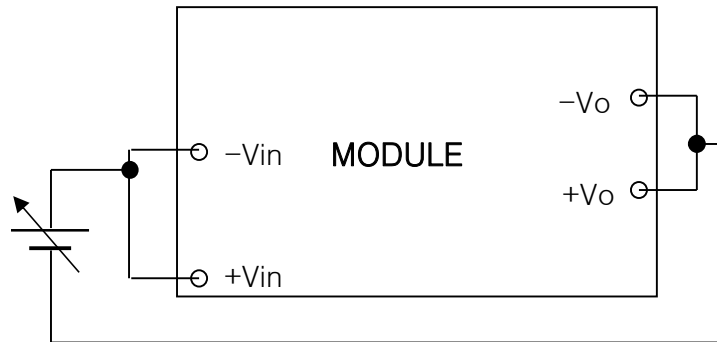
The range of ambient humidity in % over which a module may be stored long term without damage. The storage humidity range is from 5% to 95%RH.

6. Isolation

Isolation Resistance

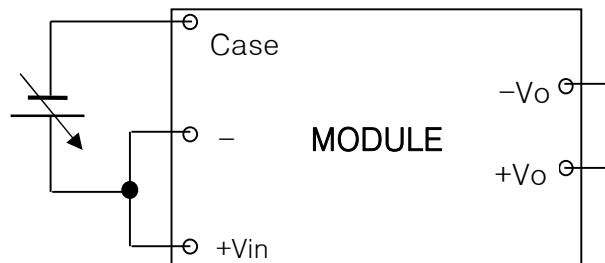
The electrical separation between input and output of a module by means of the power transformer. The isolation resistance is a function of materials and spacings employed throughout the module. Please don't test with a voltage above standard voltage for the Isolation Resistance Test.

< INPUT - OUTPUT >



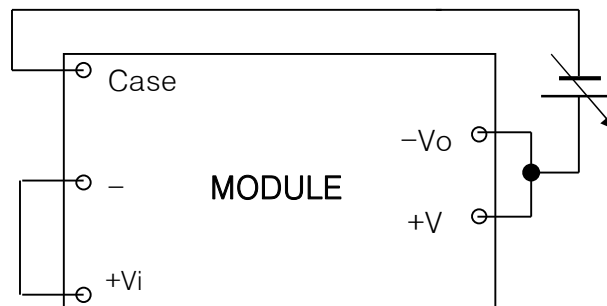
500VDC, 100MΩ

< INPUT - Case >



500VDC, 100MΩ

< OUTPUT - FRG >

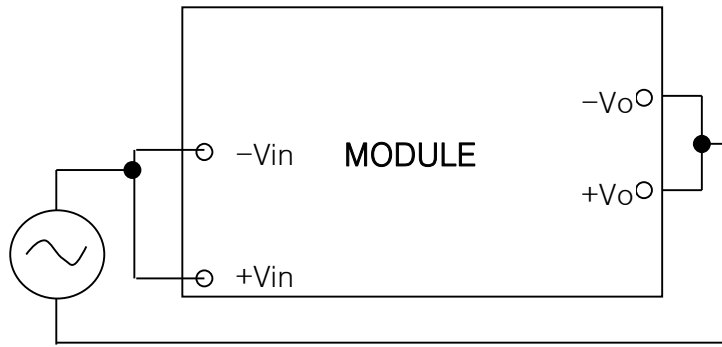


500VDC, 70MΩ

Withstand Voltage

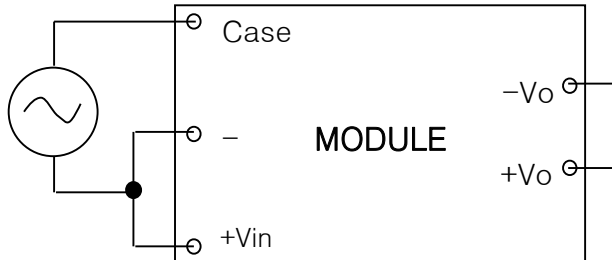
For the withstand voltage test, the applied voltage must be increased gradually from zero to the testing value, and then decreased gradually at shut down. Especially stay away from use of a timer. Where a pulse of several times the applied voltage can be generated.

< INPUT - OUTPUT >



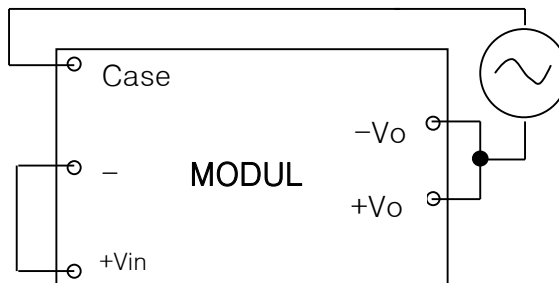
500VAC (10mA) 1minute

< INPUT - FRG >



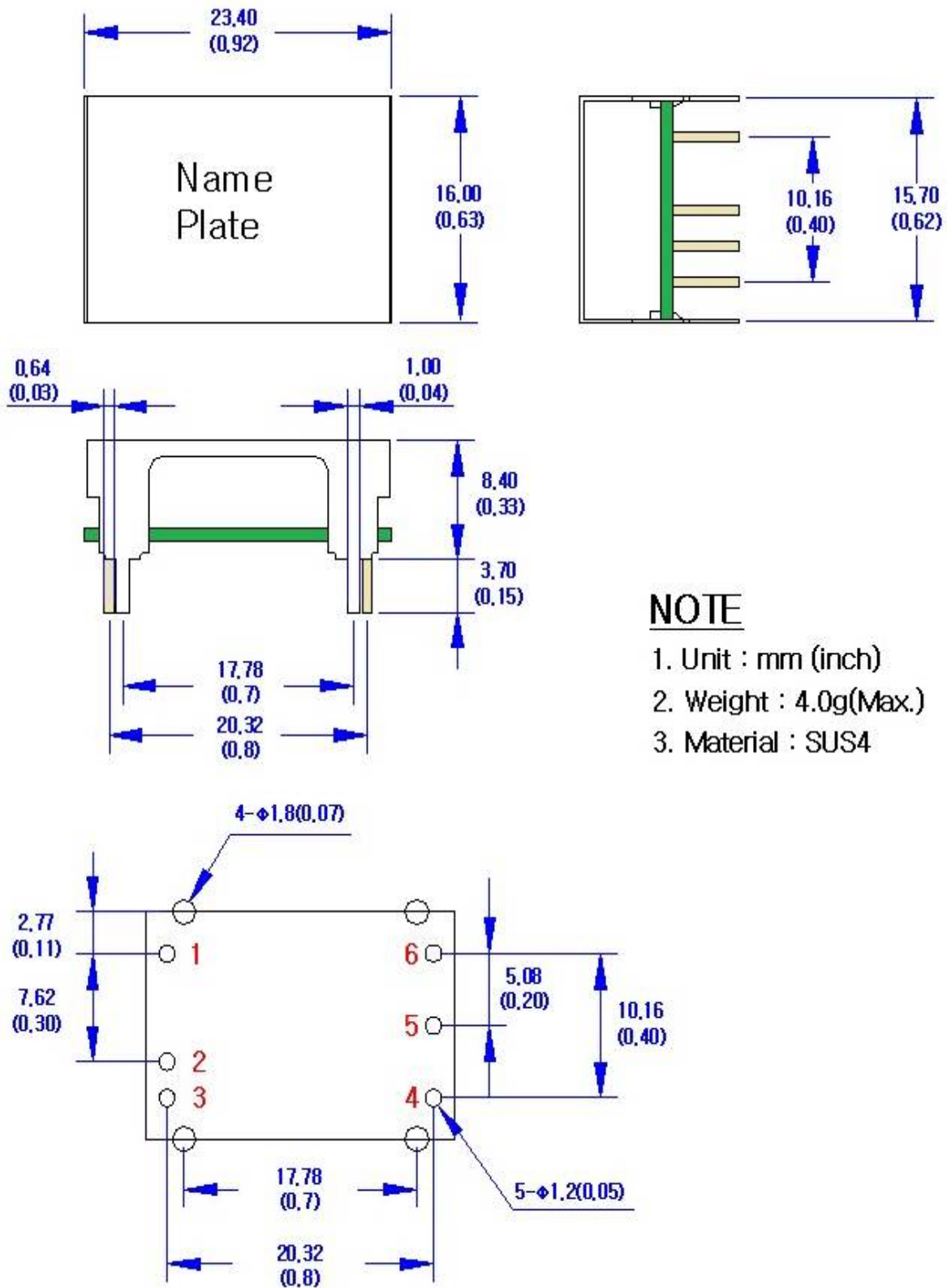
500VAC (10mA) 1minute

< OUTPUT - FRG >



500VAC (10mA) 1minute

7. Outline Dimensions <Unit : mm (inch)>



NOTE

1. Unit : mm (inch)
2. Weight : 4.0g(Max.)
3. Material : SUS4